

Product Summary

- $V_R > 10V$
- $I_F = 750mA$
- $I_R = 1\mu A$

Description and Applications

This compact SOD323 packaged Schottky diode offers users an excellent performance combination comprising high current operation, extremely low leakage and low forward voltage ensuring suitability for applications requiring efficient operation at higher temperatures (above 85°C) see Operational efficiency chart on page 4.

- Low power DC-DC conversion
- Level shifting
- Reverse blocking

Features and Benefits

- Extremely low leakage
- High current capability
- Low V_F , fast switching Schottky
- SOD323 package
- Package thermally rated to 150°C
- **Lead, Halogen, and Antimony Free/RoHS Compliant (Note 1)**
- **“Green” Device (Note 2)**

Mechanical Data

- Case: SOD323
- Case material: Molded Plastic. “Green” Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.0049 grams (Approximate)



SOD323



Device symbol



Partmark as example only for orientation

Top View Pin Configuration

Ordering Information (Note 3)

Device	Packaging	Shipping
ZLLS410TA	SOD323	3,000/Tape & Reel
ZLLS410TC	SOD323	10,000/Tape & Reel

- Notes:
1. No purposefully added lead. Halogen and Antimony Free.
 2. Diodes Inc's "Green" Policy can be found on our website at <http://www.diodes.com>
 3. For Packaging Details, go to our website at <http://www.diodes.com>.

Marking Information



41 = Product Type Marking Code

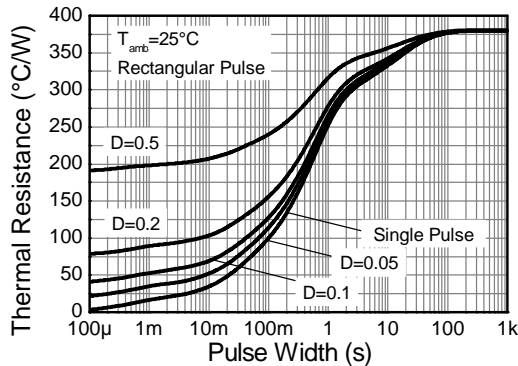
Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	10	V
Continuous Forward Current	I _F	750	mA
Peak Repetitive Forward Current	I _{FPK}	1.35	A
Rectangular Pulse Duty Cycle			
Non Repetitive Forward Current	I _{FSM}	17	A
		4	A

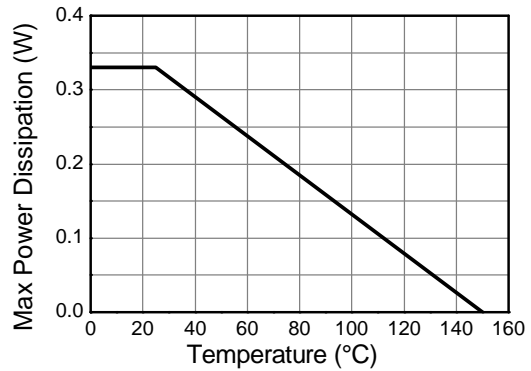
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation, T _A = 25°C			
Single Die Continuous (Note 4)	P _D	0.33	W
Single Die Measured at t < 5 secs (Note 5)		0.39	W
Junction to Ambient (Note 4)	R _{θJA}	379	°C/W
Junction to Ambient (Note 5)	R _{θJA}	317	°C/W
Storage Temperature Range	T _{STG}	-55 to +150	°C

Notes: 4. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
5. For a device surface mounted on FRB PCB measured at t < 5secs.



Transient Thermal Impedance

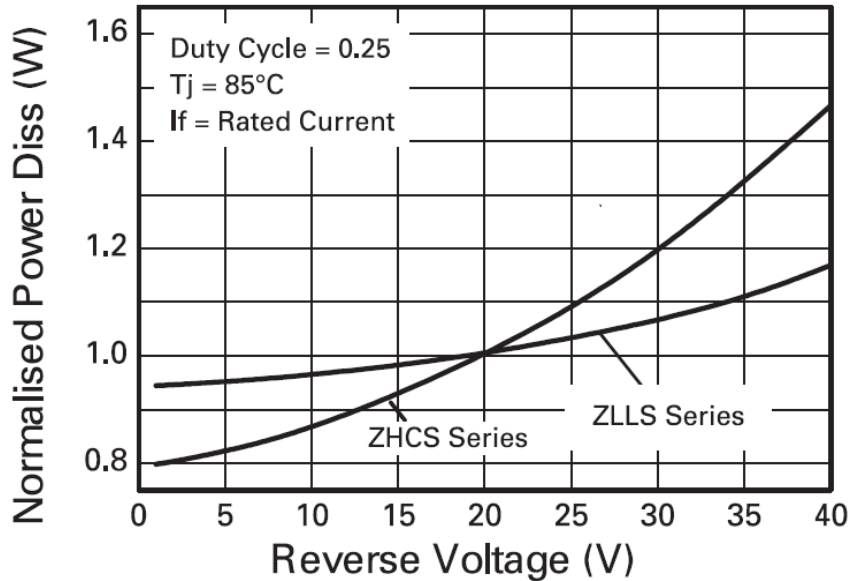


Derating Curve

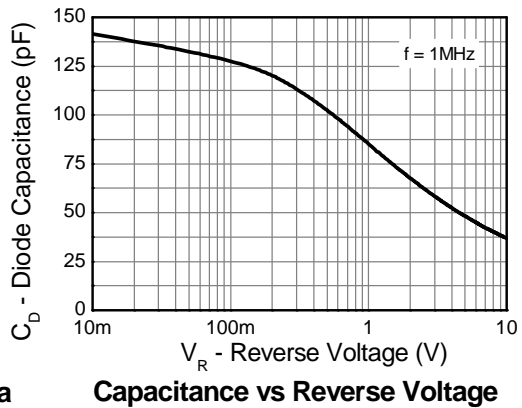
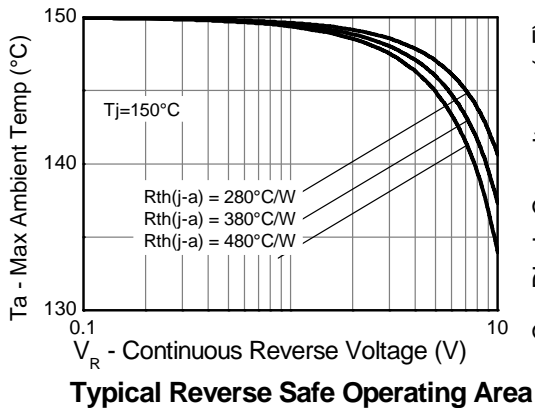
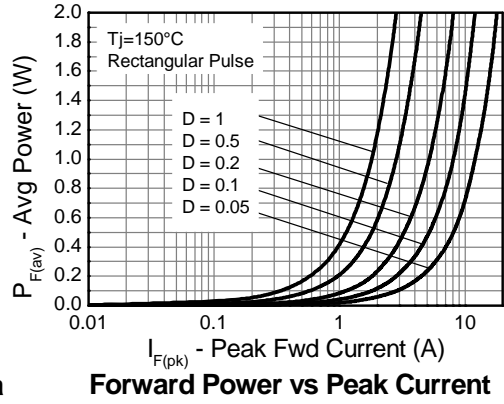
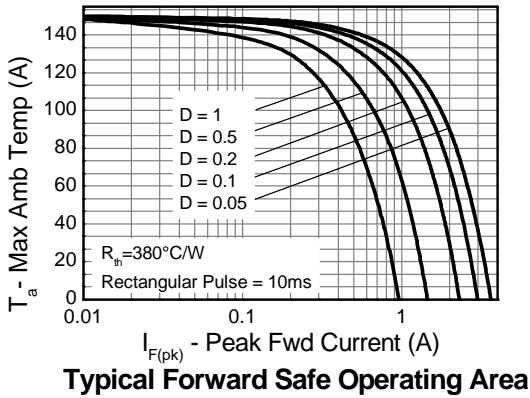
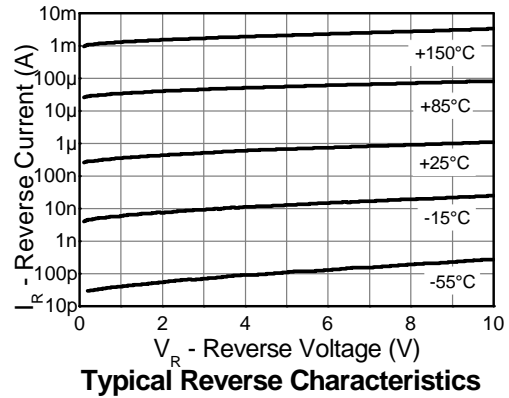
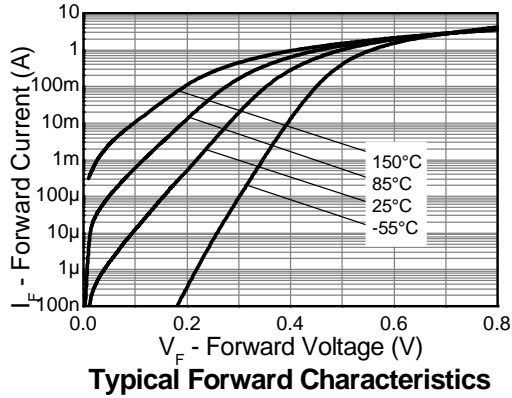
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	10	–	–	V	I _R = 200μA
Forward Voltage (Note 6)	V _F	–	285	300	mV	I _F = 10mA
		–	350	380	mV	I _F = 100mA
		–	500	580	mV	I _F = 1A
Reverse Current	I _R	–	0.5	4	μA	V _R = 5V
		–	0.7	5	μA	V _R = 8V
		–	1	6	μA	V _R = 10V
		–	–	200	μA	V _R = 8V, T _A = 85°C
Diode Capacitance	C _D	–	37	–	pF	f = 1MHz, V _R = 10V
Reverse Recovery Time	t _{rr}	–	3	–	ns	Switched from I _F = 500mA to V _R = 5.5V
Reverse Recovery Charge	Q _{rr}	–	210	–	pC	Measured @ I _R = 50mA. di/dt = 500mA/ns, R _{source} = 6Ω; R _{load} = 10Ω

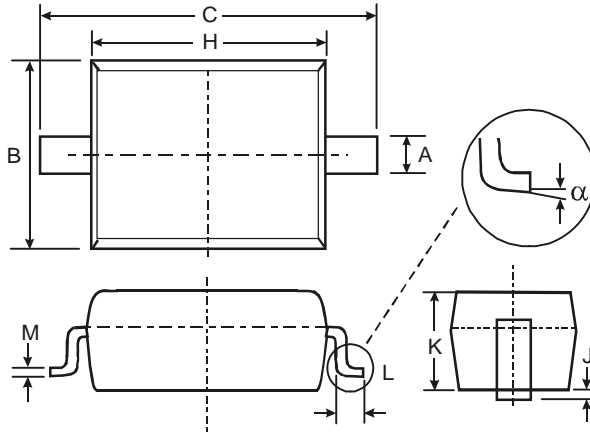
Notes: 6. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle < 2%

Operational efficiency chart

Operational Efficiency Example

The operational efficiency chart indicates the beneficial use of the ZLLS series diodes in applications requiring higher voltage, higher temperature operation. Circuits requiring low voltage low temperature operation will benefit from using Zetex low V_F ZHCS series diodes.

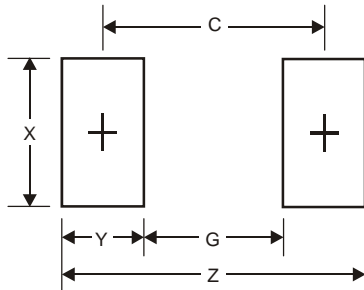


Package Outline Dimensions



SOD323		
Dim	Min	Max
A	0.25	0.35
B	1.20	1.40
C	2.30	2.70
H	1.60	1.80
J	0.00	0.10
K	1.0	1.1
L	0.20	0.40
M	0.10	0.15
α	0°	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.75
G	1.05
X	0.65
Y	1.35
C	2.40

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